

DOCKET NO.:

PATENT

COMBINED DECLARATION AND POWER OF ATTORNEY

Kazuhiro MAENO and Eiji KONO

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name; and

I verily believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: SEMICONDUCTOR DEVICE

the specification of which:

(X) is attached hereto.

( ) was filed on \_\_\_\_\_ as Application Serial No. \_\_\_\_\_ and was amended on \_\_\_\_\_ (if applicable).

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose to the U.S. Patent and Trademark Office all information known to be material to the patentability of this application in accordance with 37 CFR § 1.56.

I hereby claim foreign priority benefits under 35 U.S.C. § 119(a-d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of any application on which priority is claimed:

Country	Number	Date Filed	Priority Claimed
<u>Japan</u>	<u>2000-124447</u>	<u>25th/April/2000</u>	<u>YES</u>
_____	_____	_____	_____
_____	_____	_____	_____

I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose to the U.S. Patent and Trademark Office all information known to be material to patentability as defined in 37 CFR § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application:

Application Serial No.	Filing Date	Status (patented, pending)
PCT/JP01/03524	24th/April/2001	Pending
_____	_____	_____
_____	_____	_____

I hereby claim the benefit under 35 U.S.C. § 119(e) of any United States provisional application(s) listed below:

Provisional Appln. No.	Filing Date
_____	_____
_____	_____
_____	_____

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith: Steven J. Rocci and Michael P. Dunnam, Registration Nos. 30,489 and 32,611 of the firm of WOODCOCK WASHBURN LLP, One Liberty Place - 46th Floor, Philadelphia, Pennsylvania 19103, and

Address all telephone calls and correspondence to:

Michael P. Dunnam, Esq.  
WOODCOCK WASHBURN LLP  
One Liberty Place - 46th Floor  
Philadelphia, PA 19103  
Telephone No. 215-568-3100.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

1	Full Name Kazuhiro MAENO	Inventor's Signature Kazuhiro Maeno	Date Oct. 25, 2001
	Residence Aichi-ken, Japan		Citizenship Japan JPX
	Post Office Address c/o KABUSHIKI KAISHA TOYOTA JIDOSHOKKI, 2-1, Toyoda-cho, Kariya-shi, Aichi-ken, 448-8671, Japan		
2	Full Name Eiji KONO	Inventor's Signature Eiji Kono	Date Oct. 25, 2001
	Residence Aichi-ken, Japan		Citizenship Japan JPX
	Post Office Address c/o KABUSHIKI KAISHA TOYOTA JIDOSHOKKI, 2-1, Toyoda-cho, Kariya-shi, Aichi-ken, 448-8671, Japan		
3	Full Name	Inventor's Signature	Date
	Residence		Citizenship
	Post Office Address		
4	Full Name	Inventor's Signature	Date
	Residence		Citizenship
	Post Office Address		
5	Full Name	Inventor's Signature	Date
	Residence		Citizenship
	Post Office Address		